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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	5
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 4x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	8-SOIC (0.209", 5.30mm Width)
Supplier Device Package	8-SOIJ
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic12c671-04e-sm

PIC12C67X

3.1 Clocking Scheme/Instruction Cycle

The clock input (from OSC1) is internally divided by four to generate four non-overlapping quadrature clocks, namely Q1, Q2, Q3 and Q4. Internally, the program counter (PC) is incremented every Q1, and the instruction is fetched from the program memory and latched into the instruction register in Q4. The instruction is decoded and executed during the following Q1 through Q4. The clocks and instruction execution flow is shown in Figure 3-2.

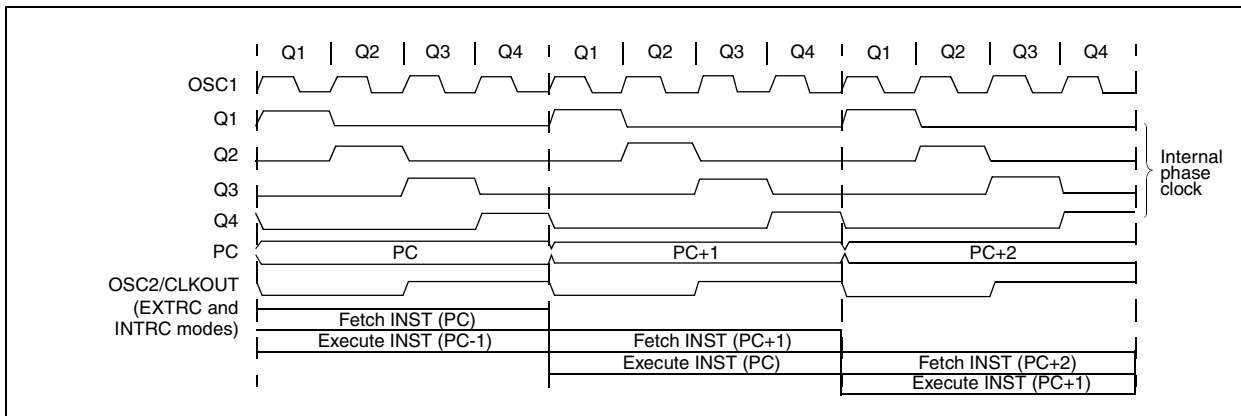
3.2 Instruction Flow/Pipelining

An "Instruction Cycle" consists of four Q cycles (Q1, Q2, Q3 and Q4). The instruction fetch and execute are pipelined such that fetch takes one instruction cycle, while decode and execute takes another instruction cycle. However, due to the pipelining, each instruction effectively executes in one cycle. If an instruction causes the program counter to change (i.e., GOTO), then two cycles are required to complete the instruction (Example 3-1).

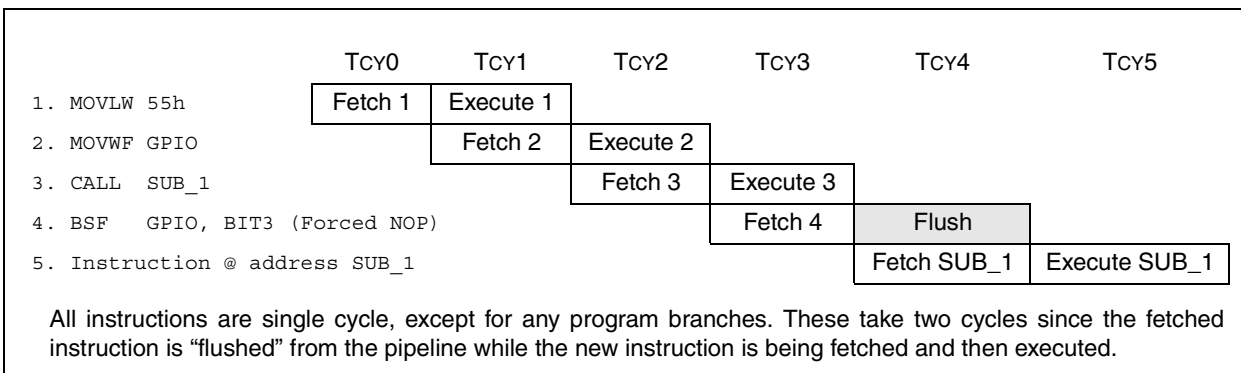
A fetch cycle begins with the program counter (PC) incrementing in Q1.

In the execution cycle, the fetched instruction is latched into the "Instruction Register" (IR) in cycle Q1. This instruction is then decoded and executed during the Q2, Q3, and Q4 cycles. Data memory is read during Q2 (operand read) and written during Q4 (destination write).

FIGURE 3-2: CLOCK/INSTRUCTION CYCLE



EXAMPLE 3-1: INSTRUCTION PIPELINE FLOW



PIC12C67X

4.2.2.6 PCON REGISTER

The Power Control (PCON) Register contains a flag bit to allow differentiation between a Power-on Reset (POR), an external $\overline{\text{MCLR}}$ Reset and a WDT Reset.

REGISTER 4-6: PCON REGISTER (ADDRESS 8Eh)

U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	U-0
—	—	—	—	—	—	POR	—
bit7							bit0
bit 7-2: Unimplemented: Read as '0'							
bit 1: $\overline{\text{POR}}$: Power-on Reset Status bit							
1 = No Power-on Reset occurred							
0 = A Power-on Reset occurred (must be set in software after a Power-on Reset occurs)							
bit 0: Unimplemented: Read as '0'							

R = Readable bit
W = Writable bit
U = Unimplemented bit, read as '0'
- n = Value at POR reset

4.2.2.7 OSCCAL REGISTER

The Oscillator Calibration (OSCCAL) Register is used to calibrate the internal 4 MHz oscillator. It contains four bits for fine calibration and two other bits to either increase or decrease frequency.

REGISTER 4-7: OSCCAL REGISTER (ADDRESS 8Fh)

R/W-0	R/W-1	R/W-1	R/W-1	R/W-0	R/W-0	U-0	U-0
CAL3	CAL2	CAL1	CAL0	CALFST	CALSLW	—	—
bit7				bit0			

R = Readable bit
W = Writable bit
U = Unimplemented bit, read as '0'
- n = Value at POR reset

bit 7-4: **CAL<3:0>**: Fine Calibration

bit 3: **CALFST**: Calibration Fast
1 = Increase frequency
0 = No change

bit 2: **CALSLW**: Calibration Slow
1 = Decrease frequency
0 = No change

bit 1-0: **Unimplemented**: Read as '0'

Note: If CALFST = 1 and CALSLW = 1, CALFST has precedence.

6.0 EEPROM PERIPHERAL OPERATION

The PIC12CE673 and PIC12CE674 each have 16 bytes of EEPROM data memory. The EEPROM memory has an endurance of 1,000,000 erase/write cycles and a data retention of greater than 40 years. The EEPROM data memory supports a bi-directional 2-wire bus and data transmission protocol. These two-wires are serial data (SDA) and serial clock (SCL), that are mapped to bit6 and bit7, respectively, of the GPIO register (SFR 06h). Unlike the GP0-GP5 that are connected to the I/O pins, SDA and SCL are only connected to the internal EEPROM peripheral. For most applications, all that is required is calls to the following functions:

```
; Byte_Write: Byte write routine
;   Inputs: EEPROM Address    EEADDR
;           EEPROM Data      EEDATA
;   Outputs: Return 01 in W if OK, else
;           return 00 in W
;
; Read_Current: Read EEPROM at address
;               currently held by EE device.
;   Inputs: NONE
;   Outputs: EEPROM Data      EEDATA
;           Return 01 in W if OK, else
;           return 00 in W
;
; Read_Random: Read EEPROM byte at supplied
;               address
;   Inputs: EEPROM Address    EEADDR
;   Outputs: EEPROM Data      EEDATA
;           Return 01 in W if OK,
;           else return 00 in W
```

The code for these functions is available on our web site (www.microchip.com). The code will be accessed by either including the source code FL67XINC.ASM or by linking FLASH67X.ASM. FLASH67X.INC provides external definition to the calling program.

6.0.1 SERIAL DATA

SDA is a bi-directional pin used to transfer addresses and data into and data out of the device.

For normal data transfer, SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the START and STOP conditions.

6.0.2 SERIAL CLOCK

This SCL signal is used to synchronize the data transfer from and to the EEPROM.

6.1 Bus Characteristics

The following **bus protocol** is to be used with the EEPROM data memory. In this section, the term “processor” is used to denote the portion of the PIC12C67X that interfaces to the EEPROM via software.

- Data transfer may be initiated only when the bus is not busy.

During data transfer, the data line must remain stable whenever the clock line is HIGH. Changes in the data line while the clock line is HIGH will be interpreted as a START or STOP condition.

Accordingly, the following bus conditions have been defined (Figure 6-3).

6.1.1 BUS NOT BUSY (A)

Both data and clock lines remain HIGH.

6.1.2 START DATA TRANSFER (B)

A HIGH to LOW transition of the SDA line while the clock (SCL) is HIGH determines a START condition. All commands must be preceded by a START condition.

6.1.3 STOP DATA TRANSFER (C)

A LOW to HIGH transition of the SDA line while the clock (SCL) is HIGH determines a STOP condition. All operations must be ended with a STOP condition.

6.1.4 DATA VALID (D)

The state of the data line represents valid data when, after a START condition, the data line is stable for the duration of the HIGH period of the clock signal.

The data on the line must be changed during the LOW period of the clock signal. There is one bit of data per clock pulse.

Each data transfer is initiated with a START condition and terminated with a STOP condition. The number of the data bytes transferred between the START and STOP conditions is determined by the available data EEPROM space.

7.2 Using Timer0 with an External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The requirements ensure the external clock can be synchronized with the internal phase clock (Tosc). Also, there is a delay in the actual incrementing of Timer0 after synchronization.

7.2.1 EXTERNAL CLOCK SYNCHRONIZATION

When no prescaler is used, the external clock input is used as the clock source. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 7-5). Therefore, it is necessary for T0CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

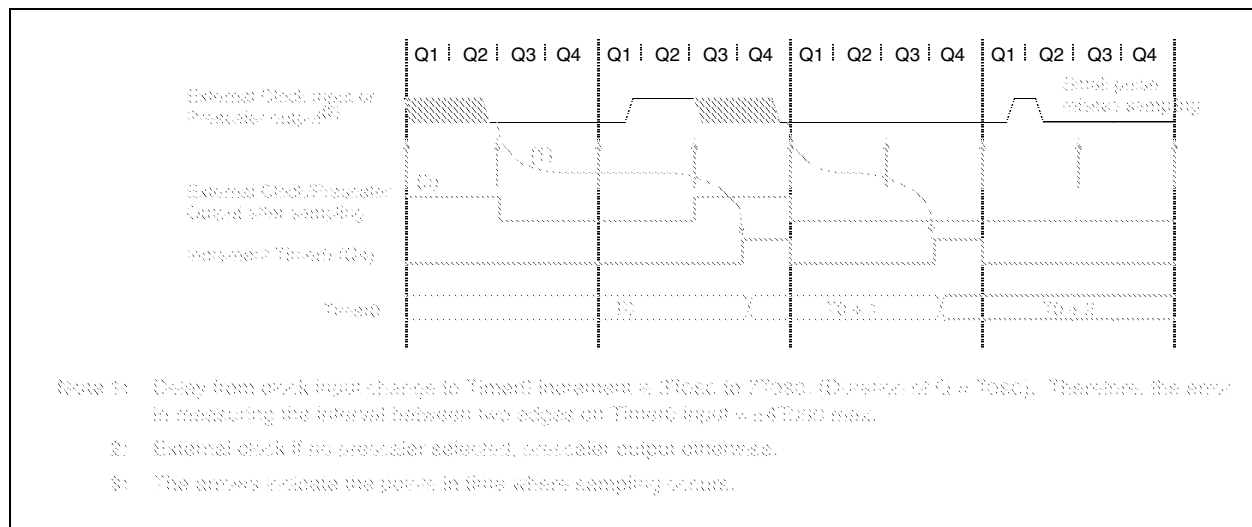
When a prescaler is used, the external clock input is divided by the asynchronous ripple-counter type pres-

caler, so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T0CKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T0CKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

7.2.2 TMR0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the Timer0 module is actually incremented. Figure 7-5 shows the delay from the external clock edge to the timer incrementing.

FIGURE 7-5: TIMER0 TIMING WITH EXTERNAL CLOCK



7.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control, (i.e., it can be changed “on-the-fly” during program execution).

Note: To avoid an unintended device RESET, the following instruction sequence (shown in Example 7-1) must be executed when changing the prescaler assignment from Timer0 to the WDT. This sequence must be followed even if the WDT is disabled.

EXAMPLE 7-1: CHANGING PRESCALER (TIMER0→WDT)

```
BCF    STATUS, RP0    ;Bank 0
CLRF   TMR0           ;Clear TMR0 & Prescaler
BSF    STATUS, RP0    ;Bank 1
CLRWDT           ;Clears WDT
MOVLW  b'xxxx1xxx'    ;Select new prescale
MOVWF  OPTION_REG     ;value & WDT
BCF    STATUS, RP0    ;Bank 0
```

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 7-2.

EXAMPLE 7-2: CHANGING PRESCALER (WDT→TIMER0)

```
CLRWDT           ;Clear WDT and
                  ;prescaler
BSF     STATUS, RP0 ;Bank 1
MOVLW   b'xxx0xxx' ;Select TMR0, new
                  ;prescale value and
MOVWF   OPTION_REG ;clock source
BCF     STATUS, RP0 ;Bank 0
```

TABLE 7-1: REGISTERS ASSOCIATED WITH TIMER0

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR	Value on all other Resets
01h	TMR0	Timer0 module's register								xxxx xxxx	uuuu uuuu
0Bh/8Bh	INTCON	GIE	PEIE	TOIE	INTE	GPIE	TOIF	INTF	GPIF	0000 000x	0000 000u
81h	OPTION	GPPU	INTEDG	T0CS	T0SE	PSA	PS2	PS1	PS0	1111 1111	1111 1111
85h	TRIS	—	—	TRIS5	TRIS4	TRIS3	TRIS2	TRIS1	TRIS0	--11 1111	--11 1111

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by Timer0.

8.2 Selecting the A/D Conversion Clock

The A/D conversion time per bit is defined as TAD. The A/D conversion requires 9.5 TAD per 8-bit conversion. The source of the A/D conversion clock is software selected. The four possible options for TAD are:

- 2TOSC
- 8TOSC
- 32TOSC
- Internal ADC RC oscillator

For correct A/D conversions, the A/D conversion clock (TAD) must be selected to ensure a minimum TAD time of 1.6 μ s. If the minimum TAD time of 1.6 μ s can not be obtained, TAD should be $\leq 8 \mu$ s for preferred operation.

Table 8-1 shows the resultant TAD times derived from the device operating frequencies and the A/D clock source selected.

8.3 Configuring Analog Port Pins

The ADCON1 and TRIS Registers control the operation of the A/D port pins. The port pins that are desired as analog inputs must have their corresponding TRIS bits set (input). If the TRIS bit is cleared (output), the digital output level (VOH or VOL) will be converted.

The A/D operation is independent of the state of the CHS<2:0> bits and the TRIS bits.

Note 1: When reading the port register, all pins configured as analog input channel will read as cleared (a low level). Pins configured as digital inputs, will convert an analog input. Analog levels on a digitally configured input will not affect the conversion accuracy.

2: Analog levels on any pin that is defined as a digital input (including the AN<3:0> pins) may cause the input buffer to consume current that is out of the devices specification.

TABLE 8-1: TAD vs. DEVICE OPERATING FREQUENCIES

AD Clock Source (TAD)		Device Frequency		
Operation	ADCS<1:0>	4 MHz	1.25 MHz	333.33 kHz
2TOSC	00	500 ns ⁽²⁾	1.6 μ s	6 μ s
8TOSC	01	2.0 μ s	6.4 μ s	24 μ s ⁽³⁾
32TOSC	10	8.0 μ s	25.6 μ s ⁽³⁾	96 μ s ⁽³⁾
Internal ADC RC Oscillator ⁽⁵⁾	11	2 - 6 μ s ^(1,4)	2 - 6 μ s ^(1,4)	2 - 6 μ s ⁽¹⁾

Note 1: The RC source has a typical TAD time of 4 μ s.

2: These values violate the minimum required TAD time.

3: For faster conversion times, the selection of another clock source is recommended.

4: While in RC mode, with device frequency above 1 MHz, conversion accuracy is out of specification.

5: For extended voltage devices (LC), please refer to Electrical Specifications section.

9.0 SPECIAL FEATURES OF THE CPU

What sets a microcontroller apart from other processors are special circuits to deal with the needs of real-time applications. The PIC12C67X family has a host of such features intended to maximize system reliability, minimize cost through elimination of external components, provide power saving operating modes and offer code protection. These are:

- Oscillator selection
- Reset
 - Power-on Reset (POR)
 - Power-up Timer (PWRT)
 - Oscillator Start-up Timer (OST)
- Interrupts
- Watchdog Timer (WDT)
- SLEEP
- Code protection
- ID locations
- In-circuit serial programming

The PIC12C67X has a Watchdog Timer, which can be shut off only through configuration bits. It runs off its own RC oscillator for added reliability. There are two timers that offer necessary delays on power-up. One is the Oscillator Start-up Timer (OST), intended to keep

the chip in reset until the crystal oscillator is stable. The other is the Power-up Timer (PWRT), which provides a fixed delay of 72 ms (nominal) on power-up only, designed to keep the part in reset while the power supply stabilizes. With these two timers on-chip, most applications need no external reset circuitry.

SLEEP mode is designed to offer a very low current power-down mode. The user can wake-up from SLEEP through external reset, Watchdog Timer Wake-up, or through an interrupt. Several oscillator options are also made available to allow the part to fit the application. The INTRC/EXTRC oscillator option saves system cost, while the LP crystal option saves power. A set of configuration bits are used to select various options.

9.1 Configuration Bits

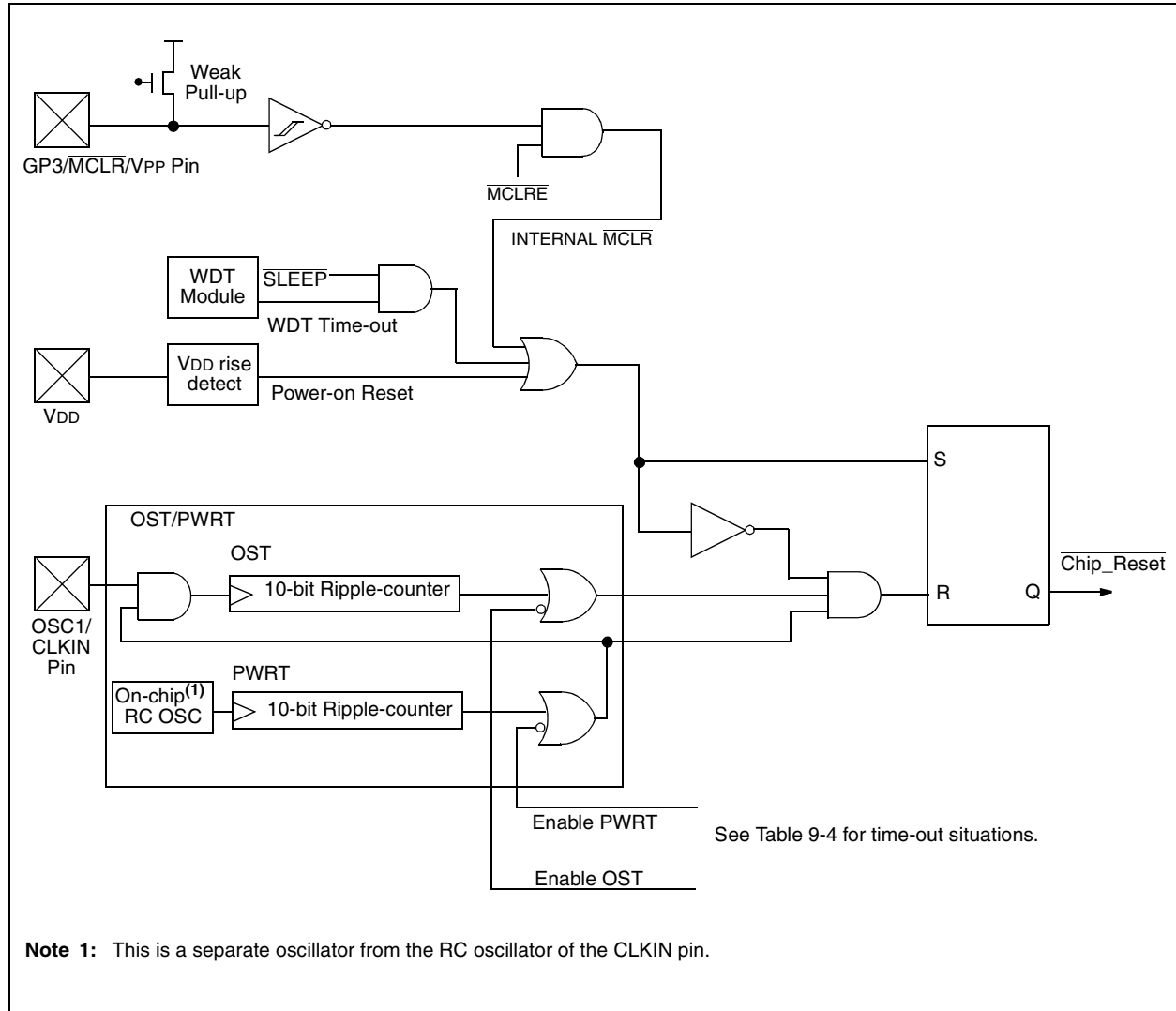
The configuration bits can be programmed (read as '0') or left unprogrammed (read as '1') to select various device configurations. These bits are mapped in program memory location 2007h.

The user will note that address 2007h is beyond the user program memory space. In fact, it belongs to the special test/configuration memory space (2000h-3FFFh), which can be accessed only during programming.

REGISTER 9-1: CONFIGURATION WORD

CP1	CP0	CP1	CP0	CP1	CP0	MCLR	CP1	CP0	PWRT	WDTE	FOSC2	FOSC1	FOSC0	Register: Address	CONFIG 2007h
bit13													bit0		
bit 13-8, CP<1:0> : Code Protection bit pairs ⁽¹⁾ 6-5: 11 = Code protection off 10 = Locations 400h through 7FEh code protected (do not use for PIC12C671 and PIC12CE673) 01 = Locations 200h through 7FEh code protected 00 = All memory is code protected bit 7: MCLR : Master Clear Reset Enable bit 1 = Master Clear Enabled 0 = Master Clear Disabled bit 4: PWRT : Power-up Timer Enable bit 1 = PWRT disabled 0 = PWRT enabled bit 3: WDTE : Watchdog Timer Enable bit 1 = WDT enabled 0 = WDT disabled bit 2-0: FOSC<2:0> : Oscillator Selection bits 111 = EXTRC, Clockout on OSC2 110 = EXTRC, OSC2 is I/O 101 = INTRC, Clockout on OSC2 100 = INTRC, OSC2 is I/O 011 = Invalid Selection 010 = HS Oscillator 001 = XT Oscillator 000 = LP Oscillator															
Note 1: All of the CP<1:0> pairs have to be given the same value to enable the code protection scheme listed.															

FIGURE 9-6: SIMPLIFIED BLOCK DIAGRAM OF ON-CHIP RESET CIRCUIT



PIC12C67X

10.2 Instruction Descriptions

ADDLW Add Literal and W

Syntax: [*label*] ADDLW *k*

Operands: $0 \leq k \leq 255$

Operation: $(W) + k \rightarrow (W)$

Status Affected: C, DC, Z

Encoding:

11	111x	kkkk	kkkk
----	------	------	------

Description: The contents of the W register are added to the eight bit literal 'k' and the result is placed in the W register.

Words: 1

Cycles: 1

Example ADDLW 0x15

Before Instruction
W = 0x10
After Instruction
W = 0x25

ANDLW And Literal with W

Syntax: [*label*] ANDLW *k*

Operands: $0 \leq k \leq 255$

Operation: $(W) .AND. (k) \rightarrow (W)$

Status Affected: Z

Encoding:

11	1001	kkkk	kkkk
----	------	------	------

Description: The contents of W register are AND'ed with the eight bit literal 'k'. The result is placed in the W register.

Words: 1

Cycles: 1

Example ANDLW 0x5F

Before Instruction
W = 0xA3
After Instruction
W = 0x03

ADDWF Add W and f

Syntax: [*label*] ADDWF *f,d*

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(W) + (f) \rightarrow (\text{dest})$

Status Affected: C, DC, Z

Encoding:

00	0111	dfff	ffff
----	------	------	------

Description: Add the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example ADDWF FSR, 0

Before Instruction
W = 0x17
FSR = 0xC2
After Instruction
W = 0xD9
FSR = 0xC2

ANDWF AND W with f

Syntax: [*label*] ANDWF *f,d*

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: $(W) .AND. (f) \rightarrow (\text{dest})$

Status Affected: Z

Encoding:

00	0101	dfff	ffff
----	------	------	------

Description: AND the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example ANDWF FSR, 1

Before Instruction
W = 0x17
FSR = 0xC2
After Instruction
W = 0x17
FSR = 0x02

CLRWDT Clear Watchdog Timer

Syntax: [*label*] CLRWDT

Operands: None

Operation: 00h → WDT
0 → WDT prescaler,
1 → \overline{TO}
1 → \overline{PD}

Status Affected: \overline{TO} , \overline{PD}

Encoding:

00	0000	0110	0100
----	------	------	------

Description: CLRWDT instruction resets the Watchdog Timer. It also resets the prescaler of the WDT. Status bits \overline{TO} and \overline{PD} are set.

Words: 1

Cycles: 1

Example

Before Instruction
WDT counter = ?

After Instruction
WDT counter = 0x00
WDT prescaler = 0
 \overline{TO} = 1
 \overline{PD} = 1

COMF Complement f

Syntax: [*label*] COMF f,d

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: (\bar{f}) → (dest)

Status Affected: Z

Encoding:

00	1001	dfff	ffff
----	------	------	------

Description: The contents of register 'f' are complemented. If 'd' is 0, the result is stored in W. If 'd' is 1, the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example

COMF REG1, 0

Before Instruction
REG1 = 0x13

After Instruction
REG1 = 0x13
W = 0xEC

DECF Decrement f

Syntax: [*label*] DECF f,d

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: (f) - 1 → (dest)

Status Affected: Z

Encoding:

00	0011	dfff	ffff
----	------	------	------

Description: Decrement register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

Words: 1

Cycles: 1

Example

DECF CNT, 1

Before Instruction
CNT = 0x01
Z = 0

After Instruction
CNT = 0x00
Z = 1

DECFSZ Decrement f, Skip if 0

Syntax: [*label*] DECFSZ f,d

Operands: $0 \leq f \leq 127$
 $d \in [0,1]$

Operation: (f) - 1 → (dest); skip if result = 0

Status Affected: None

Encoding:

00	1011	dfff	ffff
----	------	------	------

Description: The contents of register 'f' are decremented. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'. If the result is 0, the next instruction, which is already fetched, is discarded. A NOP is executed instead making it a two cycle instruction.

Words: 1

Cycles: 1(2)

Example

HERE DECFSZ CNT, 1
GOTO LOOP

CONTINUE
•
•
•

Before Instruction
PC = address HERE

After Instruction
CNT = CNT - 1
if CNT = 0,
PC = address CONTINUE
if CNT ≠ 0,
PC = address HERE+1

SWAPF		Swap Nibbles in f							
Syntax:	[<i>label</i>] SWAPF f,d								
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$								
Operation:	$(f<3:0>) \rightarrow (dest<7:4>),$ $(f<7:4>) \rightarrow (dest<3:0>)$								
Status Affected:	None								
Encoding:	<table border="1"><tr><td>00</td><td>1110</td><td>dfff</td><td>ffff</td></tr></table>					00	1110	dfff	ffff
00	1110	dfff	ffff						
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0, the result is placed in W register. If 'd' is 1, the result is placed in register 'f'.								
Words:	1								
Cycles:	1								
Example	SWAPF REG, 0								
Before Instruction									
REG1 = 0xA5									
After Instruction									
REG1 = 0xA5									
W = 0x5A									

TRIS		Load TRIS Register								
Syntax:	[<i>label</i>] TRIS f									
Operands:	$5 \leq f \leq 7$									
Operation:	(W) → TRIS register f;									
Status Affected:	None									
Encoding:	<table border="1"><tr><td>00</td><td>0000</td><td>0110</td><td>0fff</td></tr></table>						00	0000	0110	0fff
00	0000	0110	0fff							
Description:	The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.									
Words:	1									
Cycles:	1									
Example	<table border="1"><tr><td>To maintain upward compatibility with future PIC12C67X products, do not use this instruction.</td></tr></table>						To maintain upward compatibility with future PIC12C67X products, do not use this instruction.			
To maintain upward compatibility with future PIC12C67X products, do not use this instruction.										

XORLW	Exclusive OR Literal with W				
Syntax:	[<i>label</i>] XORLW k				
Operands:	0 ≤ k ≤ 255				
Operation:	(W) .XOR. k → (W)				
Status Affected:	Z				
Encoding:	<table><tr><td>11</td><td>1010</td><td>kkkk</td><td>kkkk</td></tr></table>	11	1010	kkkk	kkkk
11	1010	kkkk	kkkk		
Description:	The contents of the W register are XOR'ed with the eight bit literal 'k'. The result is placed in the W register.				
Words:	1				
Cycles:	1				
Example:	XORLW 0xAF Before Instruction W = 0xB5 After Instruction W = 0x1A				

XORWF

Exclusive OR W with f

Syntax:

[*label*] XORWF f,d

Operands:

0 ≤ f ≤ 127
d ∈ [0,1]

Operation:

(W) .XOR. (f) → (dest)

Status Affected:

Z

Encoding:

00	0110	dfff	ffff
----	------	------	------

Description:

Exclusive OR the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.

Words:

1

Cycles:

1

Example

XORWF REG 1

Before Instruction

REG = 0xAF

W = 0xB5

After Instruction

REG = 0x1A

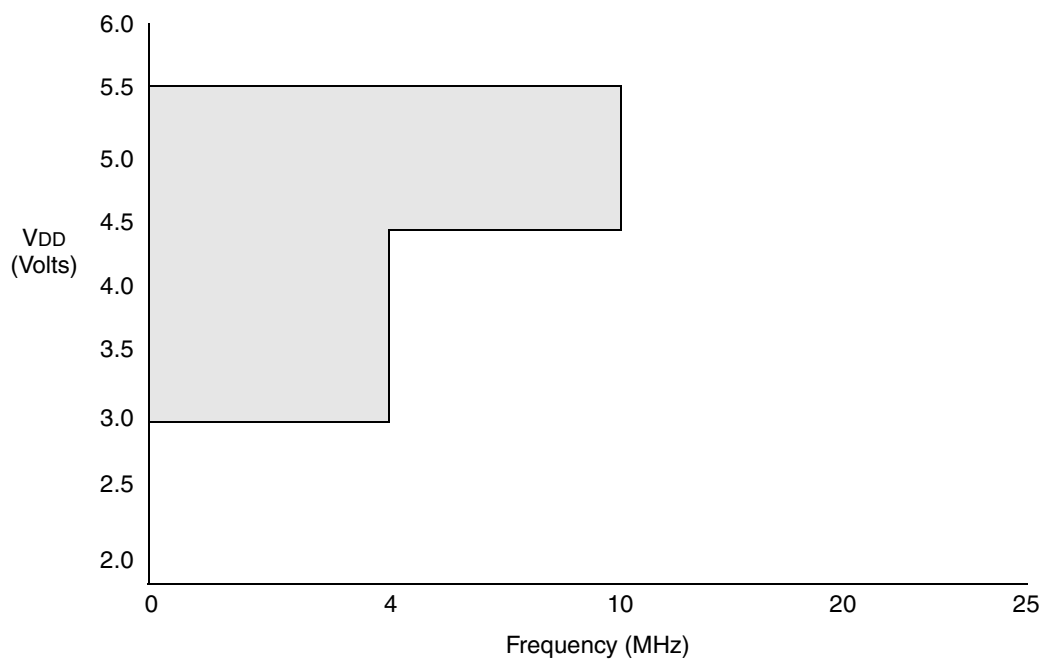
W = 0xB5

PIC12C67X

NOTES:

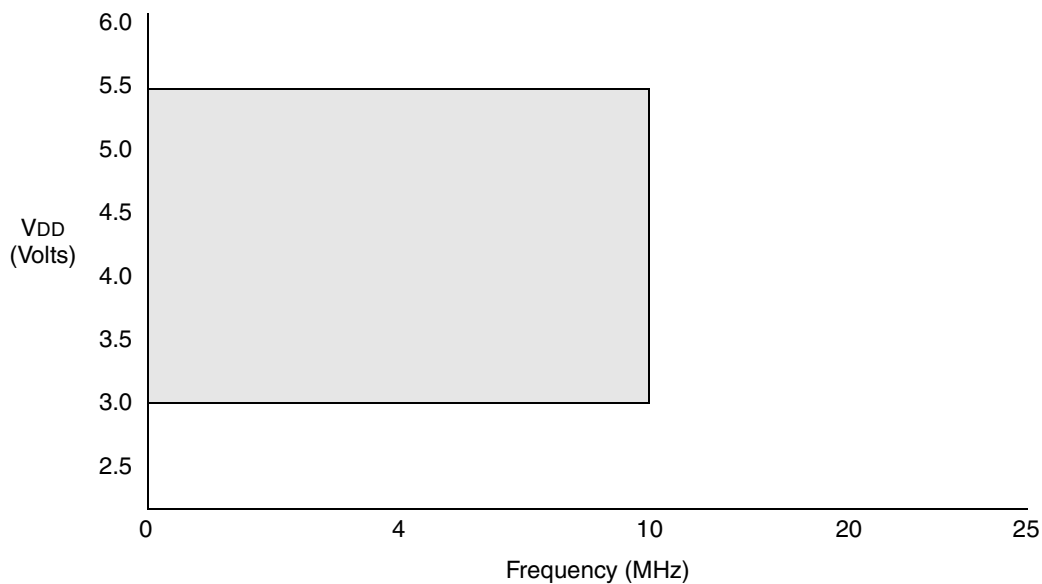
PIC12C67X

FIGURE 12-1: PIC12C67X VOLTAGE-FREQUENCY GRAPH, $-40^{\circ}\text{C} \leq T_A < 0^{\circ}\text{C}$, $+70^{\circ}\text{C} < T_A \leq +125^{\circ}\text{C}$



- Note 1:** The shaded region indicates the permissible combinations of voltage and frequency.
- 2:** The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.

FIGURE 12-2: PIC12C67X VOLTAGE-FREQUENCY GRAPH, $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$



- Note 1:** The shaded region indicates the permissible combinations of voltage and frequency.
- 2:** The maximum rated speed of the part limits the permissible combinations of voltage and frequency. Please reference the Product Identification System section for the maximum rated speed of the parts.

PIC12C67X

12.1 DC Characteristics: PIC12C671/672 (Commercial, Industrial, Extended) PIC12CE673/674 (Commercial, Industrial, Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise specified)					
		Operating Temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ (extended)					
Parm No.	Characteristic	Sym	Min	Typ ⁽¹⁾	Max	Units	Conditions
D001	Supply Voltage	V _{DD}	3.0		5.5	V	
D002	RAM Data Retention Voltage ⁽²⁾	V _{DR}		1.5*		V	Device in SLEEP mode
D003	V _{DD} Start Voltage to ensure Power-on Reset	V _{POR}		V _{SS}		V	See section on Power-on Reset for details
D004	V _{DD} Rise Rate to ensure Power-on Reset	SV _{DD}	0.05*			V/ms	See section on Power-on Reset for details
D010	Supply Current ⁽³⁾	I _{DD}	—	1.2	2.5	mA	F _{OSC} = 4MHz, V _{DD} = 3.0V XT and EXTRC mode (Note 4)
D010C			—	1.2	2.5	mA	F _{OSC} = 4MHz, V _{DD} = 3.0V INTRC mode (Note 6)
			—	2.2	8	mA	F _{OSC} = 10MHz, V _{DD} = 5.5V HS mode
D010A			—	19	29	μA	F _{OSC} = 32kHz, V _{DD} = 3.0V, WDT disabled LP mode, Commercial Temperature
			—	19	37	μA	F _{OSC} = 32kHz, V _{DD} = 3.0V, WDT disabled LP mode, Industrial Temperature
			—	32	60	μA	F _{OSC} = 32kHz, V _{DD} = 3.0V, WDT disabled LP mode, Extended Temperature
D020	Power-down Current ⁽⁵⁾	I _{PD}	—	0.25	6	μA	V _{DD} = 3.0V, Commercial, WDT disabled
D021			—	0.25	7	μA	V _{DD} = 3.0V, Industrial, WDT disabled
D021B			—	2	14	μA	V _{DD} = 3.0V, Extended, WDT disabled
			—	0.5	8	μA	V _{DD} = 5.5V, Commercial, WDT disabled
			—	0.8	9	μA	V _{DD} = 5.5V, Industrial, WDT disabled
			—	3	16	μA	V _{DD} = 5.5V, Extended, WDT disabled
D022	Watchdog Timer Current	ΔI _{WDT}	—	2.2	5	μA	V _{DD} = 3.0V, Commercial
			—	2.2	6	μA	V _{DD} = 3.0V, Industrial
			—	4	11	μA	V _{DD} = 3.0V, Extended
D028	Supply Current ⁽³⁾ During read/write to EEPROM peripheral	ΔI _{EE}	—	0.1	0.2	mA	F _{OSC} = 4MHz, V _{DD} = 5.5V, SCL = 400kHz For PIC12CE673/674 only

* These parameters are characterized but not tested.

Note 1: Data in Typical ("Typ") column is based on characterization results at 25°C. This data is for design guidance only and is not tested.

2: This is the limit to which V_{DD} can be lowered in SLEEP mode without losing RAM data.

3: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.

a) The test conditions for all I_{DD} measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to V_{SS}, T_{0CKI} = V_{DD},
MCLR = V_{DD}; WDT disabled.

b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode.

4: For EXTRC osc configuration, current through R_{EXT} is not included. The current through the resistor can be estimated by the formula:

$I_r = V_{DD}/2R_{EXT}$ (mA) with R_{EXT} in kΩ.

5: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V_{DD} or V_{SS}.

6: INTRC calibration value is for 4MHz nominal at 5V, 25°C.

12.4 DC CHARACTERISTICS: PIC12LC671/672 (Commercial, Industrial) PIC12LCE673/674 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise specified) Operating temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) Operating voltage V_{DD} range as described in DC spec Section 12.1 and Section 12.2.							
DC CHARACTERISTICS							
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D030	Input Low Voltage I/O ports with TTL buffer	V_{IL}	V_{SS}	—	0.8V	V	For $4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$ otherwise
D031	with Schmitt Trigger buffer		V_{SS}	—	$0.15V_{DD}$	V	
D032	MCLR, GP2/T0CKI/AN2/INT (in EXTRC mode)		V_{SS}	—	$0.2V_{DD}$	V	
D033	OSC1 (in EXTRC mode)		V_{SS}	—	$0.2V_{DD}$	V	
D033	OSC1 (in XT, HS, and LP)		V_{SS}	—	$0.3V_{DD}$	V	
D040	Input High Voltage I/O ports with TTL buffer	V_{IH}	2.0V	—	V_{DD}	V	For $4.5\text{V} \leq V_{DD} \leq 5.5\text{V}$ otherwise For entire V_{DD} range
D040A			$0.25V_{DD} + 0.8\text{V}$	—	V_{DD}	V	
D041	with Schmitt Trigger buffer		$0.8V_{DD}$	—	V_{DD}	V	
D042	MCLR, GP2/T0CKI/AN2/INT		$0.8V_{DD}$	—	V_{DD}	V	
D042A	OSC1 (XT, HS, and LP)		$0.7V_{DD}$	—	V_{DD}	V	
D043	OSC1 (in EXTRC mode)		$0.9V_{DD}$	—	V_{DD}	V	
D060	Input Leakage Current (Notes 2, 3) I/O ports	I_{IL}	—	—	± 1	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$, Pin at hi-impedance
D061	GP3/MCLR (Note 5)		—	—	± 30	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$
D061A	GP3 (Note 6)		—	—	± 5	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$
D062	GP2/T0CKI		—	—	± 5	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$
D063	OSC1		—	—	± 5	μA	$V_{SS} \leq V_{PIN} \leq V_{DD}$, XT, HS and LP osc configuration
D070	GPIO weak pull-up current (Note 4) MCLR pull-up current	I_{PUR} —	50 —	250 —	400 30	μA μA	$V_{DD} = 5\text{V}$, $V_{PIN} = V_{SS}$ $V_{DD} = 5\text{V}$, $V_{PIN} = V_{SS}$
D080	Output Low Voltage I/O ports	V_{OL}	—	—	0.6	V	$I_{OL} = 8.5\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$
D080A			—	—	0.6	V	$I_{OL} = 7.0\text{ mA}$, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$
D083	OSC2/CLKOUT		—	—	0.6	V	$I_{OL} = \text{TBD}$, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$
D083A			—	—	0.6	V	$I_{OL} = \text{TBD}$, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** In EXTRC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC12C67X be driven with external clock in RC mode.
- 2:** The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as coming out of the pin.
- 4:** Does not include GP3. For GP3 see parameters D061 and D061A.
- 5:** This spec. applies to GP3/MCLR configured as external MCLR and GP3/MCLR configured as input with internal pull-up enabled.
- 6:** This spec. applies when GP3/MCLR is configured as an input with pull-up disabled. The leakage current of the MCLR circuit is higher than the standard I/O logic.

PIC12C67X

Standard Operating Conditions (unless otherwise specified) Operating temperature $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ (commercial) $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ (industrial) Operating voltage V_{DD} range as described in DC spec Section 12.1 and Section 12.2.							
DC CHARACTERISTICS							
Param No.	Characteristic	Sym	Min	Typ†	Max	Units	Conditions
D090	Output High Voltage I/O ports (Note 3)	VOH	$V_{DD} - 0.7$	—	—	V	IOH = -3.0 mA, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$
D090A			$V_{DD} - 0.7$	—	—	V	IOH = -2.5 mA, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$
D092			$V_{DD} - 0.7$	—	—	V	IOH = TBD, $V_{DD} = 4.5\text{V}$, -40°C to $+85^{\circ}\text{C}$
D092A			$V_{DD} - 0.7$	—	—	V	IOH = TBD, $V_{DD} = 4.5\text{V}$, -40°C to $+125^{\circ}\text{C}$
	Capacitive Loading Specs on Output Pins						
D100	OSC2 pin	Cosc2	—	—	15	pF	In XT and LP modes when external clock is used to drive OSC1.
D101	All I/O pins	Cio	—	—	50	pF	

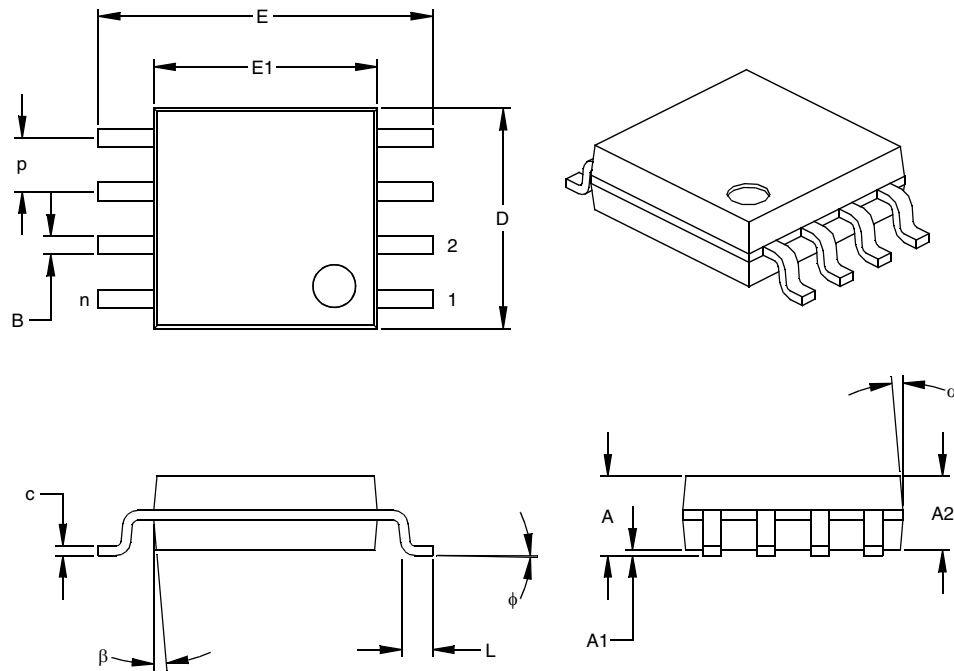
† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** In EXTRC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC12C67X be driven with external clock in RC mode.
- 2:** The leakage current on the $\overline{\text{MCLR}}$ pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as coming out of the pin.
- 4:** Does not include GP3. For GP3 see parameters D061 and D061A.
- 5:** This spec. applies to GP3/ $\overline{\text{MCLR}}$ configured as external $\overline{\text{MCLR}}$ and GP3/ $\overline{\text{MCLR}}$ configured as input with internal pull-up enabled.
- 6:** This spec. applies when GP3/ $\overline{\text{MCLR}}$ is configured as an input with pull-up disabled. The leakage current of the $\overline{\text{MCLR}}$ circuit is higher than the standard I/O logic.

NOTES:

8-Lead Plastic Small Outline (SM) – Medium, 208 mil (SOIC)

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.050			1.27	
Overall Height	A	.070	.075	.080	1.78	1.97	2.03
Molded Package Thickness	A2	.069	.074	.078	1.75	1.88	1.98
Standoff	A1	.002	.005	.010	0.05	0.13	0.25
Overall Width	E	.300	.313	.325	7.62	7.95	8.26
Molded Package Width	E1	.201	.208	.212	5.11	5.28	5.38
Overall Length	D	.202	.205	.210	5.13	5.21	5.33
Foot Length	L	.020	.025	.030	0.51	0.64	0.76
Foot Angle	φ	0	4	8	0	4	8
Lead Thickness	c	.008	.009	.010	0.20	0.23	0.25
Lead Width	B	.014	.017	.020	0.36	0.43	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

Drawing No. C04-056

PIC12C67X

NOTES: